## Amendments to the Specification:

Please amend the paragraph starting on line 6 of page 7 as follows:

Embodiments in accordance with the present invention are useful for removing organic material from a wide variety of substrates, such substrates encompassing oxidizable material or not. Therefore, it will be understood that that that while embodiments of the present invention will be described below with reference to semiconductor substrates semiconductor processing, that such is for ease of understanding and description only. Thus the scope and spirit of embodiments of the present invention advantageously include other substrates and other processing, for example liquid crystal display substrates and processing, magnetic and/or optical storage medium substrates and processing and the like.

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